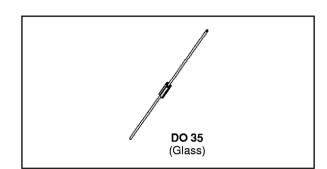


# SMALL SIGNAL SCHOTTKY DIODE



#### **DESCRIPTION**

Metal to silicon junction diode primarly intended for UHF mixers and ultrafast switching applications.

# **ABSOLUTE RATINGS** (limiting values)

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	5	V
l <sub>F</sub>	Forward Continuous Current*	30	mA
I <sub>FSM</sub>	Surge non Repetitive Forward Current*	60	mA
T <sub>stg</sub> Tj	Storage and Junction Temperature Range	- 65 to +150 -65 to +125	°C °C
TL	Maximum Lead Temperature for Soldering of from Case	230	°C

### THERMAL RESISTANCE

Symbol	Test Conditions	Value	Unit
R <sub>th(j-a)</sub>	Junction-ambient*	400	°C/W

## **ELECTRICAL CHARACTERISTICS**

## STATIC CHARACTERISTICS

Symbol		Test Conditions	Min.	Тур.	Max.	Unit
$V_{BR}$	T <sub>amb</sub> = 25°C	I <sub>R</sub> = 100μ <b>A</b>	5			>
V <sub>F</sub> (1)	T <sub>amb</sub> = 25°C	I <sub>F</sub> = 10mA			0.55	>
I <sub>R</sub> (1)	T <sub>amb</sub> = 25°C	$V_{R} = 1V$			0.05	μΑ

# DYNAMIC CHARACTERISTICS

Symbol		Min.	Тур.	Max.	Unit		
С	T <sub>amb</sub> = 25°C	$V_R = 0V$	f = 1MHz			1	рF
QS (2)	T <sub>amb</sub> = 25°C	$I_F = 10mA$				3	рC
F (3)	T <sub>amb</sub> = 25°C	f = 1GHz			6	7	dB

<sup>\*</sup> On infinite heatsink with 4mm lead length

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<sup>(1)</sup> Pulse test:  $t_p \le 300 \mu s \ \delta < 2\%$ .
(2) Measured on B-line Electronics QS-3 stored charge meter.

<sup>(3)</sup> Noise figure test :

<sup>-</sup> diode is inserted in a tuned stripline circuit

local oscillator frequency 1GHz
 local oscillator power 1mW

<sup>-</sup> intermediate frequency amplifier, tuned on 30MHz, has a noise figure 1.5dB

Figure 1. Forward current versus forward voltage (typical values).

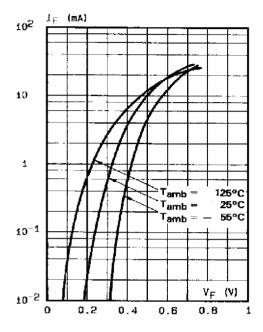


Figure 2. Capacitance C versus reverse applied voltage V<sub>R</sub> (typical values).

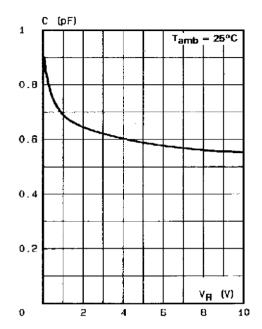


Figure 3. Reverse current versus ambient temperature.

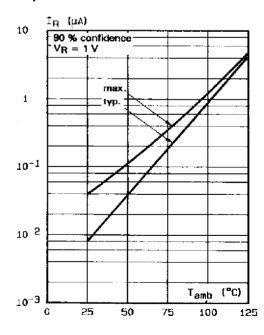
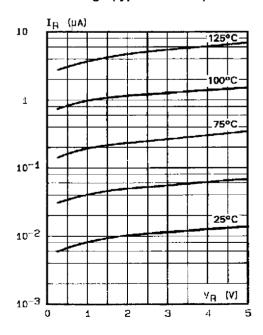
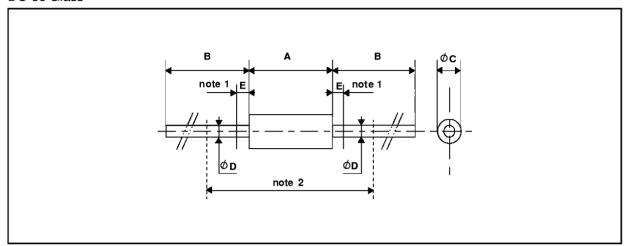


Figure 4. Reverse current versus continuous reverse voltage (typical values).



#### **PACKAGE MECHANICAL DATA**

#### DO 35 Glass



	REF. Millimeters Inches			NOTES	
REF.			llimeters Inches		
	Min.	Max.	Min.	Max.	
Α	3.050	4.500	0.120	0.117	
В	12.7		0.500		1 - The lead diameter $\varnothing$ D is not controlled over zone E
ØC	1.530	2.000	0.060	0.079	2 - The minimum axial lengh within which the device may be placed
ØD	0.458	0.558	0.018	0.022	with its leads bent at right angles is 0.59"(15 mm)
Е		1.27		0.050	

Cooling method: by convection and conduction Marking: clear, ring at cathode end. Weight: 0.15g

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